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REPLY UNDER 37 C.F.R. §1.116
EXPEDITED PROCEDURE
TECHNOLOGY CENTER 2800

Docket No.: 29936/39889
(PATENT)

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Dated: March 23, 2005

Signature: 

(Michael R. Hull)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Sang Kyun Park

Application No.: 10/749,022

Confirmation No.: 9225

Filed: December 30, 2003

Art Unit: 2812

For: METHOD OF FORMING COPPER WIRING IN
SEMICONDUCTOR DEVICE

Examiner: Lynn Ann Gurley

*Entered
w/ RCF
5-19-05*

AMENDMENT IN RESPONSE TO FINAL OFFICE ACTION

Mail Stop AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

*Shufka
5-25-05*

INTRODUCTORY COMMENTS

In response to the final office action mailed on January 24, 2005, please amend the above-identified patent application as follows.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments in support of the allowability of this application begin on page 7 of this paper.

*Keep
copy
w/ RCF
5-20-05*